



# SPECIFICATION OF PRODUCT

# 承认书

CUSTOMER:		
DESCRIPTION: _	Magnetic Buzzer	
FUSHENG P/N: _	FUET-9045-05	
CUSTOMER P/N:		
DATE:	2018-8-28	_

CUSTOMER	APPROVER	CHECKER
	Yunqing Wu	Bing Yan

泰州福声电子科技有限公司

#### FUSHENG ELECTRONICS-----Acoustic Components Professional Manufacturer

地址:江苏省泰州市海陵区凤凰西路 168 号

电话: 0086-523-86219066 传真: 0086-523-81601108

邮箱: sales@electronic-tech.cn

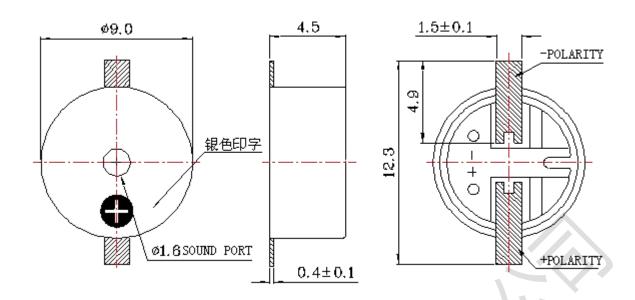
网址: www.tzfsdz.com



### 1.SPECIFICATION 规格

No.	ltem	Unit	Specification	Condition
1	Oscillation Frequency	Hz	2700	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
2	Operating Voltage	Vo-p	4~7	
3	Rated Voltage	Vo-p	5	
4	Current Consumption	mA	MAX. 80	at Rated Voltage
5	Sound Pressure Level	dB	MIN. 85	at 10cm at Rated Voltage
6	Coil Resistance	Ω	32±3	
7	Operating Temperature	$^{\circ}$	-20 ~ +70	
8	Storage Temperature	$^{\circ}$	-30 ~ +80	
9	Dimension	mm	9 x H4.5	See appearance drawing
10	Weight (MAX)	gram	0.8	
11	Housing Material		LCP(Black)	
12	Leading Pin		Tin Plated Brass(Sn)	See appearance drawing
13	Environmental Protection Regulation		RoHS	

#### 2. APPEARANCE DRAWING 尺寸图



**Tol: ± 0.5 Unit: mm** 

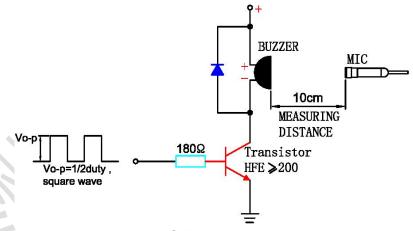
#### 3.TESTING METHOD 测量方式

#### **Standard Measurement conditions**

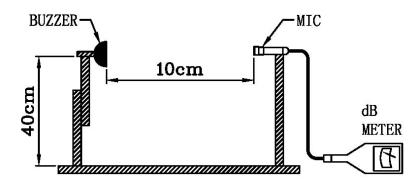
Temperature:25±2°C Humidity:45-65%

#### **Acoustic Characteristics:**

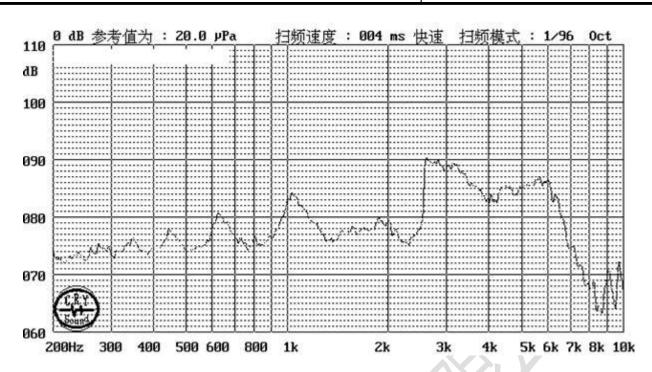
The oscillation frequency, current consumption and sound pressure are measured by the measuring instruments shown below



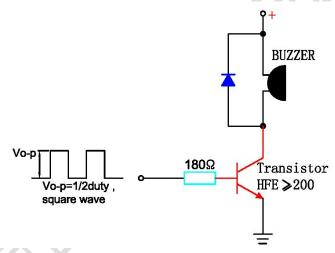
In the measuring test, buzzer is placed as follows:



#### 4. Typical Frequency Response Curve 频率



#### 5. Recommend Driving Circuit



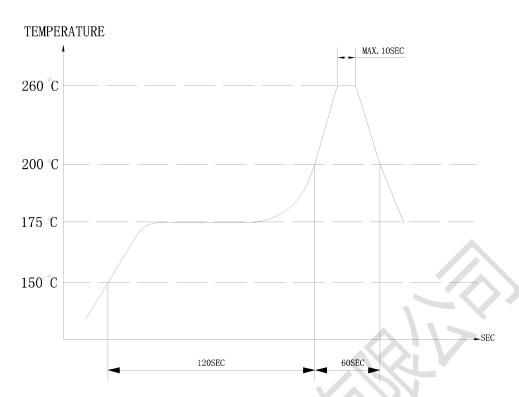
The base current Ib should high enough so that it saturates the collector current of the transistor with the CB load.

## **6. Soldering Condition**

 $(1) Recommendable\ reflow\ soldering\ condition\ is\ as\ follows$ 

(Reflow soldering is twice)

Note: It is requested that reflow soldering should be executed after heat of product goes down to normal.



Heat resistant line
(Used when heat resistant reliability test is performed)
(2)Manual soldering
Manual soldering temperature 350 °C within 5 sec.

#### 7. RELIABILITY TEST 可靠性测试

NO.	ITEM	TEST CONDITION AND REQUIREMENT
1	High Temperature Test (Storage)	After being placed in a chamber with 80 2°C for 96 hours and then being placed in normal condition for 2 hours.  Allowable variation of SPL after test: 10dB.
2	Low Temperature Test (Storage)	After being Placed in a chamber with -30 2°C for 96 hours and then being placed in normal condition for 2 hours.  Allowable variation of SPL after test: 10dB.
3	Humidity Test	After being Placed in a chamber with 90-95% R.H. at 40 2°C for 96 hours and then being placed in normal condition for 2 hours.  Allowable variation of SPL after test: 10dB.

		The part shall be subjected to 5 cycles. One cycle shall be consist of:
		+70°C
	Temperature Cycle	+25°C +25°C
4		
4	Test	-20°C
		0.5hr 0.5 0.25 0.5 0.5 0.25
		3hours
		Allowable variation of SPL after test: 10dB.
	Drop Test	Drop on a hard wood board of 4cm thick, any directions, 6 times,
5		at the height of 75cm.
		Allowable variation of SPL after test: 10dB.
	Vibration Test	After being applied vibration of amplitude of 1.5mm with 10 to 55 Hz
6		band of vibration frequency to each of 3 perpendicular directions for 2 hours.
		Allowable variation of SPL after test: 10dB.
		Lead terminals are immersed in rosin for 5 seconds and then
	Solderability Test	immersed in solder bath of +300 5°C for 3 1 seconds.
7		90% min. lead terminals shall be wet with solder
		(Except the edge of terminals).
	Terminal Strength Pulling Test	The force of 9.8N(1.0kg) is applied to each terminal in axial direction for
8		10 seconds.
		No visible damage and cutting off.
	•	

#### **TEST CONDITION.**

Standard Test Condition : a) Temperature: +5~+35℃ b) Humidity: 45-85% c) Pressure: 860-1060mbar c) 温度: +5~+35℃ b) 湿度: 45-85% c) 气压: 860-1060mbar c) Temperature: +25±2℃ b) Humidity: 60-70% c) Pressure: 860-1060mbar c) Pressur

争议时测试条件 : a) 温度:+25±2℃ b) 湿度:60-70%

#### 湿度:60-70% c) 气压:860-1060mbar

# 8. PACKING STANDARD 包装

